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FQD2N100/FQU2N100

1000V N-Channel MOSFET

General Description

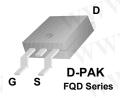
These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for electronic lamp starter and ballast.

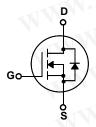
Features

- 1.6A, 1000V, $R_{DS(on)} = 9\Omega$ @V_{GS} = 10 V Low gate charge (typical 12 nC)
- Low Crss (typical 5 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- **RoHS Compliant**









Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQD2N100/FQU2N100	Units
V_{DSS}	Drain-Source Voltage		1000	V
I_D	Drain Current - Continuous (T _C = 25°C)		1.6	Α
	- Continuous (T _C = 100)°C)	1.0	Α
I _{DM}	Drain Current - Pulsed	(Note 1)	6.4	Α
V_{GSS}	Gate-Source Voltage	-76	± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	160	mJ
I _{AR}	Avalanche Current	(Note 1)	1.6	Α
E _{AR}	Repetitive Avalanche Energy	(Note 1)	5.0	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	5.5	V/ns
P_{D}	Power Dissipation (T _A = 25°C) *	400	2.5	W
	Power Dissipation (T _C = 25°C)		50	W
	- Derate above 25°C		0.4	W/°C
T_J , T_{STG}	Operating and Storage Temperature Range		-55 to +150	°C
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	41.10-	2.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *	707	50	°C/W
R _{θJA} Thermal Resistance, Junction-to-Ambient		- TKN . J.	110	°C/W

* When mounted on the minimum pad size recommended (PCB Mount)

Symbol	Parameter	Test Conditions	- 1	Min	Тур	Max	Units
Off Cha	aracteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	-	1000	=7	COI	V
ΔBV_{DSS} / ΔT_J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced	to 25°C	V-1	0.976	- - - (V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 1000 V, V _{GS} = 0 V		-	()	10	μА
		V _{DS} = 800 V, T _C = 125°C		7-4	To-	100	μА
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$			A-TO()	100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$			To	-100	nA
On Cha	aracteristics	W.T.W		-11	W 10	07.	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	*	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 0.8 A		-	7.1	9	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 50 V, I _D = 0.8 A	(Note 4)	17	1.9	100	S
Dynamic Characteristics C _{iss} Input Capacitance					400	520	pF
	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz			400	520	pF
C _{oss}	Output Capacitance				40	52	pF
C _{rss}	Reverse Transfer Capacitance	J CUL			5	6.5	pF
Switchi	ing Characteristics						
t _{d(on)}	Turn-On Delay Time	V_{DD} = 500 V, I_{D} = 2.0 A, R_{G} = 25 Ω (Note 4, 5)			13	35	ns
t _r	Turn-On Rise Time				30	70	ns
t _{d(off)}	Turn-Off Delay Time				25	60	ns
t _f	Turn-Off Fall Time				35	80	ns
Qg	Total Gate Charge	V = 000 V I = 0.0 A			12	15.5	nC
Q _{gs}	Gate-Source Charge	$V_{DS} = 800 \text{ V}, I_D = 2.0 \text{ A},$ $V_{GS} = 10 \text{ V}$ (Note 4, 5)			2.5		nC
Q_{gd}	Gate-Drain Charge				6.5		nC
Drain-S	Source Diode Characteristics at		ST	N.		1.5	A
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				6.0	A	
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 1.6 A		<u></u>		1.4	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_S = 1.0 \text{ A}$	O Mr.		520	1.7	ns
111	TROVOISC PROCESS THE	$V_{GS} = 0 \text{ V, } I_S = 2.0 \text{ A,}$ $dI_F / dt = 100 \text{ A/}\mu\text{s}$ (Note 4)			520		113

- **Notes:**1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 120mH, I $_{AS}$ = 1.6A, V $_{DD}$ = 50V, R $_{G}$ = 25 Ω , Starting T $_{J}$ = 25°C 3. I $_{SD}$ \leq 2.0A, di/dt \leq 300A/ μ s, V $_{DD}$ \leq BV $_{DSS}$, Starting T $_{J}$ = 25°C 4. Pulse Test : Pulse width \leq 300 μ s, Duty cycle \leq 2% 5. Essentially independent of operating temperature

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Typical Characteristics

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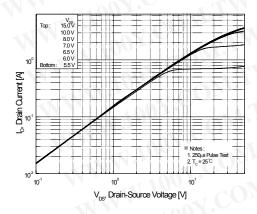


Figure 1. On-Region Characteristics

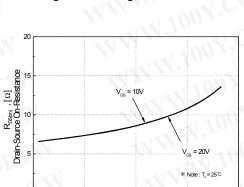


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

In, Drain Current [A]

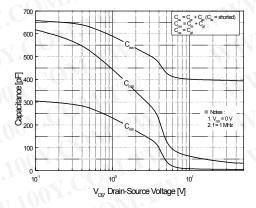


Figure 5. Capacitance Characteristics

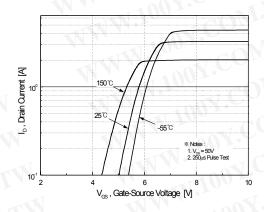


Figure 2. Transfer Characteristics

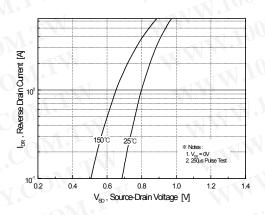


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

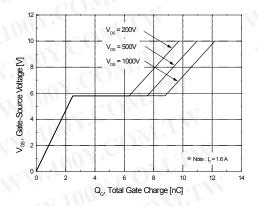


Figure 6. Gate Charge Characteristics

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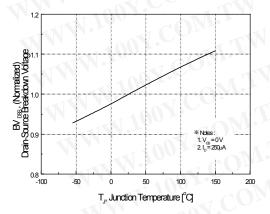


Figure 7. Breakdown Voltage Variation vs. Temperature

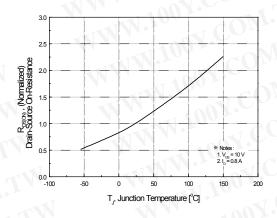


Figure 8. On-Resistance Variation vs. Temperature

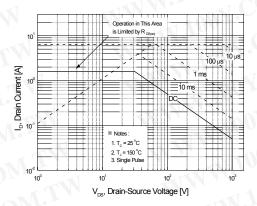


Figure 9. Maximum Safe Operating Area

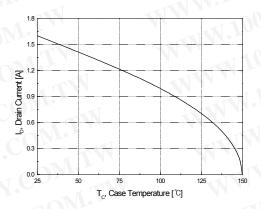


Figure 10. Maximum Drain Current vs. Case Temperature

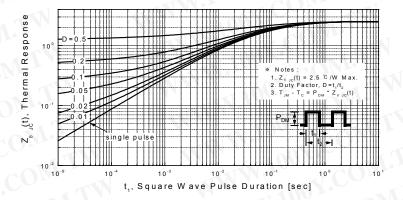
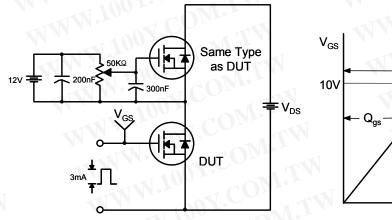
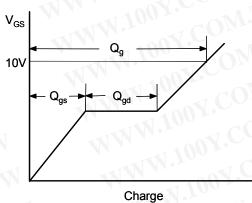


Figure 11. Transient Thermal Response Curve

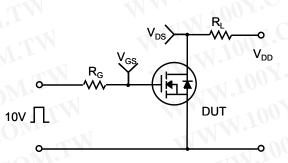
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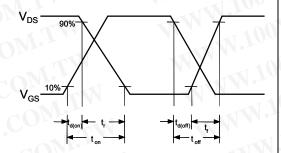
Gate Charge Test Circuit & Waveform



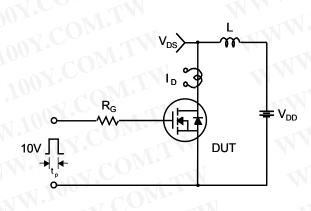


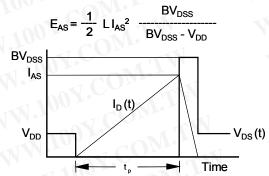
Resistive Switching Test Circuit & Waveforms





Unclamped Inductive Switching Test Circuit & Waveforms

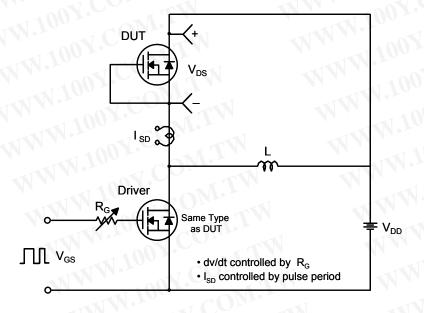


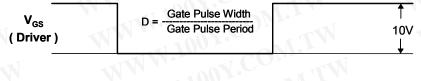


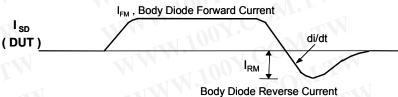
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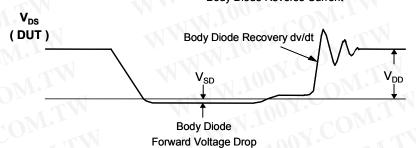
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Peak Diode Recovery dv/dt Test Circuit & Waveforms









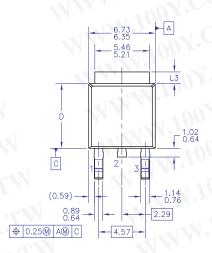
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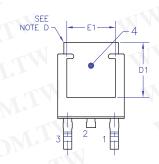
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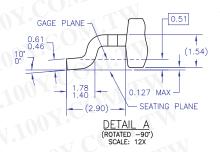
Mechanical Dimensions

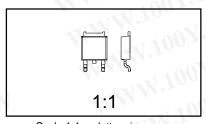
TO-252 (DPAK) (FS PKG Code 36)





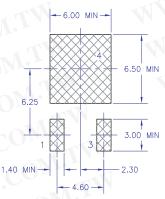




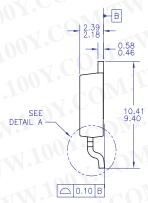


Scale 1:1 on letter size paper Dimensions shown below are in: millimeters

Part Weight per unit (gram): 0.33



LAND PATTERN RECOMMENDATION



- NOTES: UNLESS OTHERWISE SPECIFIED

 A) ALL DIMENSIONS ARE IN MILLIMETERS.

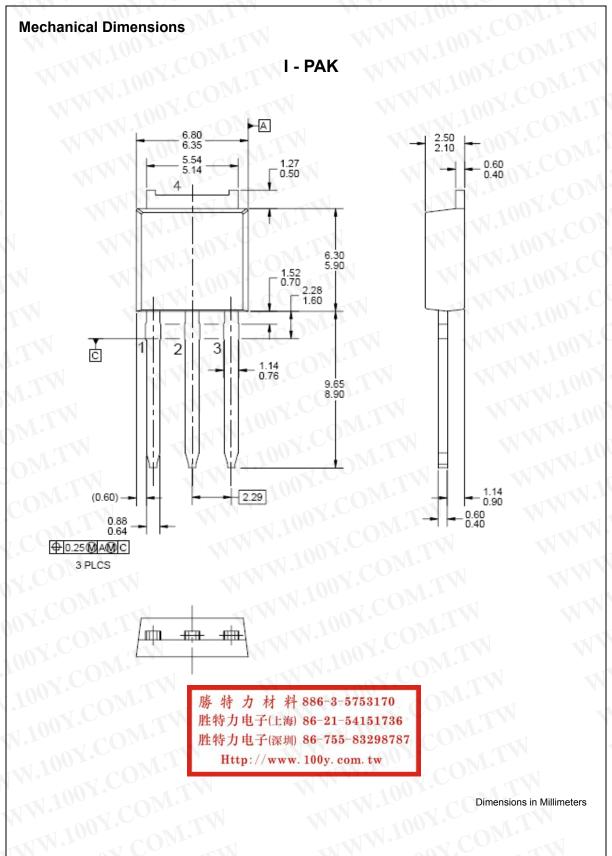
 B) THIS PACKAGE CONFORMS TO JEDEC, TO-252, ISSUE C, VARIATION AA & AB, DATED NOV. 1999.

 C) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.

 D) HEAT SINK TOP EDGE COULD BE IN CHAMFERED CORNERS OR EDGE PROTRUSION.

 F) DIMENSIONS 13.D.F1&D1 TABLE:

< 70	UPTION AA	OPTION AB
L3	0.89-1.27	1.52-2.03
D	5.97-6.22	5.33-5.59
E1	4.32 MIN	3.81 MIN
D1.	5.21 MIN	4.57 MIN



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Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

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